



## Material Content Data Sheet



<b>Sales Product Name</b>				SAK-TC397XX-256F300S BC		<b>Issued</b>		31. January 2019	
<b>MA#</b>				MA003286484					
<b>Package</b>				PG-LFBGA-292-10		<b>Weight*</b>		983.83 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	47.237	4.80	4.80	48013	48013	
wire	noble metal	palladium	7440-05-3	0.020	0.00		20		
	non noble metal	copper	7440-50-8	1.961	0.20	0.20	1993	2013	
encapsulation	organic material	carbon black	1333-86-4	0.661	0.07		672		
	plastics	epoxy resin	-	45.617	4.64		46367		
substrate	inorganic material	silicondioxide	60676-86-0	284.280	28.90	33.61	288954	335993	
	inorganic material	bariumsulfate	7727-43-7	9.349	0.95		9503		
	plastics	acrylic resin	-	10.820	1.10		10998		
	non noble metal	metal hydroxide	-	12.990	1.32		13203		
	inorganic material	amorphous silica	7631-86-9	25.979	2.64		26406		
	plastics	epoxy resin	-	45.061	4.58		45802		
	inorganic material	glass fibre wool	65997-17-3	51.958	5.28		52813		
	non noble metal	copper	7440-50-8	310.560	31.55	47.42	315665	474390	
plating	noble metal	gold	7440-57-5	1.136	0.12		1155		
	non noble metal	nickel	7440-02-0	3.110	0.32	0.44	3161	4316	
solderball	noble metal	silver	7440-22-4	4.411	0.45		4484		
	non noble metal	tin	7440-31-5	121.620	12.36	12.81	123619	128103	
glue	plastics	epoxy resin	-	1.764	0.18		1793		
	noble metal	silver	7440-22-4	5.292	0.54	0.72	5379	7172	
*deviation	< 10%					Sum in total:	100.00	1000000	

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com